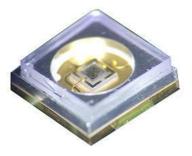
Draft Specification For UV-C Series

BRT-B44LD8A1CS0



Features

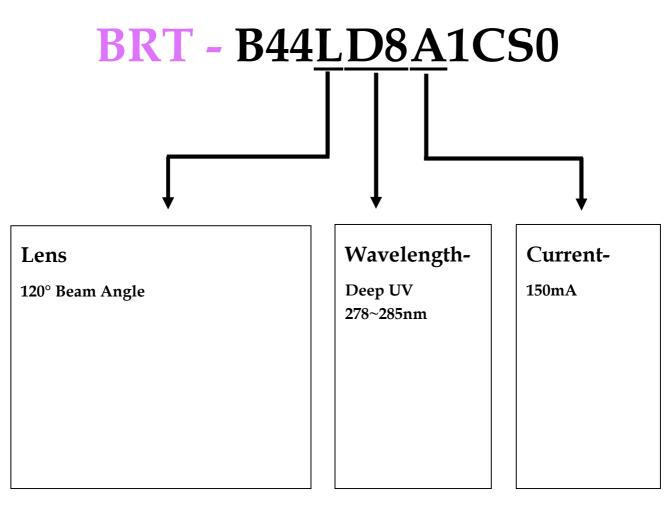
- Deep Ultraviolet LED
- Dimension : 4.4mm(L)×4.4mm(W)
- All Metal Design Cu Substrate/Al reflector
- View Angle 120°
- Low thermal resistance

Applications

- Disinfection
- Chemical and Biological analysis

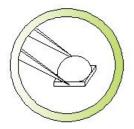








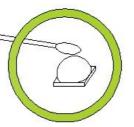
Do not poke the Led Lens with sharp object



Hold the Led only by the substrate



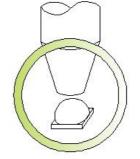
Do not stack assembled PCB



Clean the LED surface with cotton bud



Do not hold the Led with hand



Use pick and place nozzle per recommendation in data sheet



Do not press or push the Led Lens

Absolute Maximum Ratings

Parameter Symbol Value Unit **Power Dissipation** Р 1.5 w **Forward Current** $\mathbf{I}_{\mathbf{F}}$ 150 mA °C/W Thermal Resistance, Junction-Case Rth, J-C1 15 - 40°C to + 60°C **Operating Temperature Range** Topr **Storage Temperature Range** - 40°C to + 100°C T_{stg} **Soldering Condition** T_{sol} 260°C For 5 Seconds

Note: 1. The thermal resistance value is measured with MCPCB (Star).

Initial Electrical/Optical Characteristics

Symbol Min Тур Parameter Max Unit Peak wavelength λ_p 278 -285 nm **Radiant Flux** 8 Φ_{e} 10 mW **Radiant Irradiance** Ee 2.8 mW/cm^2 **Forward Voltage** $\mathbf{V}_{\mathbf{F}}$ 7 10 V Spectra half-width 15 Δλ nm

Note

1. Forward voltage measurement allowance is ± 0.2 V.

2. Radiant flux measurement allowance is $\pm 10\%$.

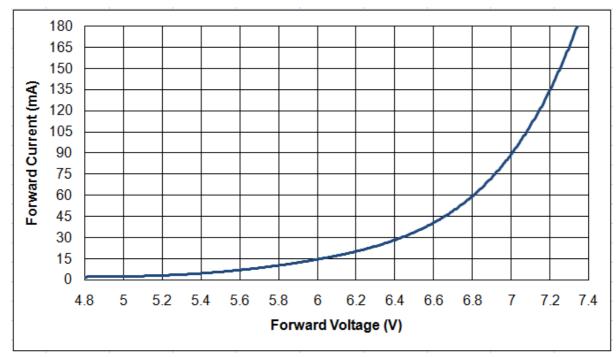
3. Irradiance tested at a distance 10mm from Al reflector.

4. Wavelength measurement allowance is ± 3nm.

(Tj=25℃)

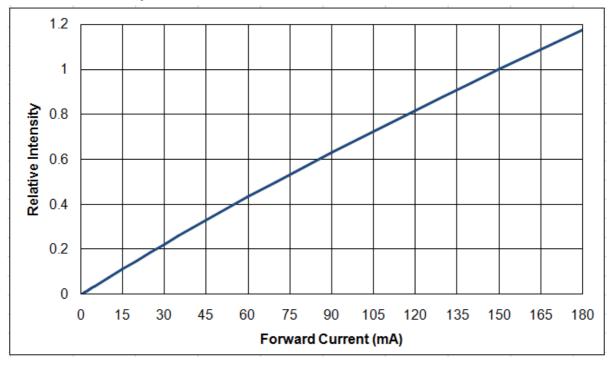
(Tj=25°C)

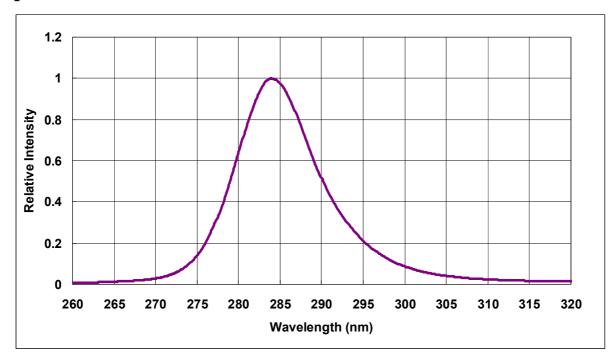
Characteristic Diagram



• Forward Current vs. Forward Voltage

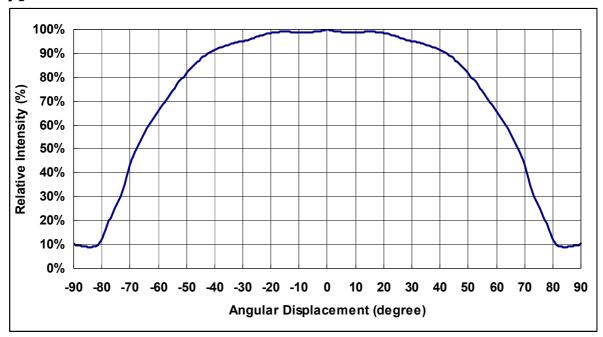
• Relative Intensity vs. Forward Current





• Spectral Power Distribution

• Typical Radiation Pattern



• Bin Code List for Reference

						(Tj=25℃)
Item	Bin code	Symbol	Condition	Min.	Max.	Unit
Forward Voltage ¹	Е	V _F	I _F =150 [mA]	5	6	
	F			6	7	
	G			7	8	V
	Н			8	9	
	J			9	10	

Note

1. Forward voltage measurement allowance is ± 0.2 V.

Outline Dimension

B44LD8A1CS0

Unit : mm

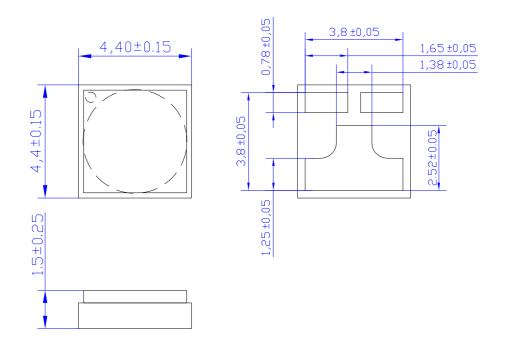
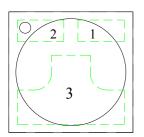
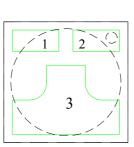


Fig. Package Outline Drawing.

Pad Configuration



ТОР



BOTTOM

PADFunction1Cathode2Anode3Thermal

Fig. Pad configuration.

Recommended Solder Pattern

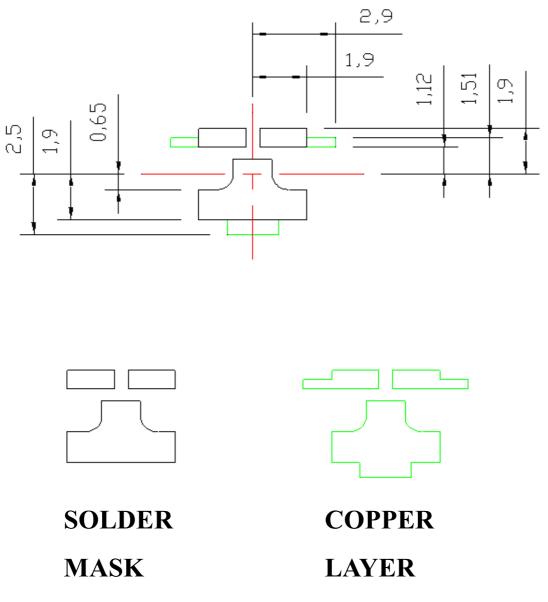


Fig. Solder Pad Layout.

Shipping Package Style

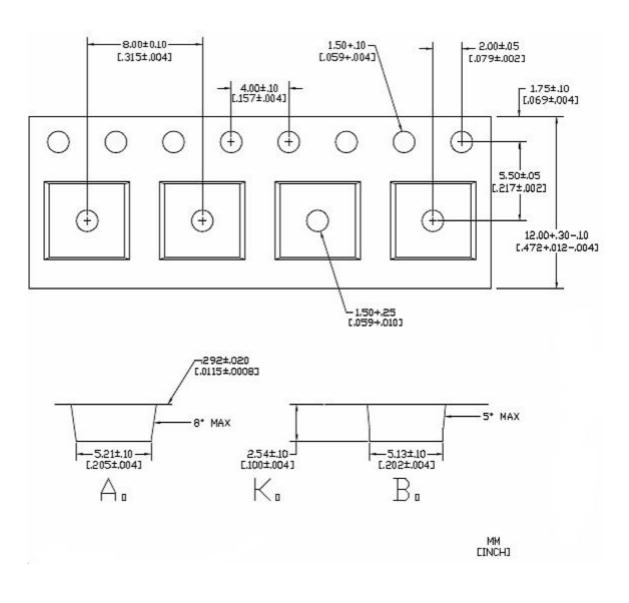
Lens Type

Tapping Dimension Packaging Specification

120 Degree Lens Type :

- Moisture proof bag.
- 1 Reel/bag.
- Q'ty: 800(MAX)/Reel.

Unit : mm



Label Formation

F	P/N:	****	BIN	Rank	÷	XXXXXXXXX	хх
L	LOT:	****		Q't y	:	XXXXPCS	ххх

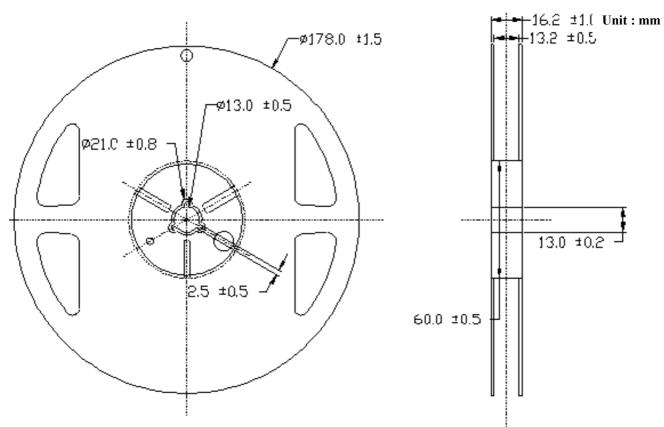
75mm*8mm

Package

Box Type	Dimension (mm)	Reel/Box	120°Lens Type(Pcs)
Small Box(S)	230x85x265	5 Reel/Box	4000
Middle Box(M)	470x265x270	30 Reel/Box	24000
Large Box(L)	470x435x270	50 Reel/Box	40000

Reel Packaging :

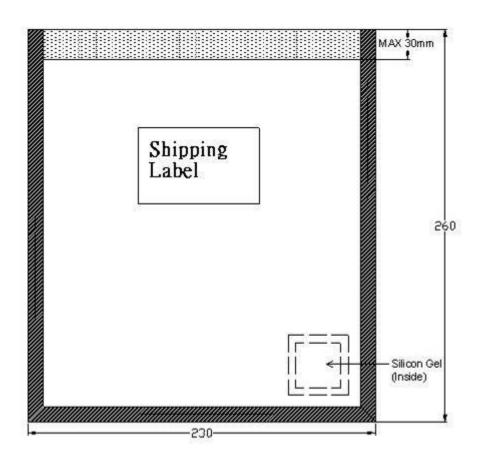
Reel Part :



The information in this document is subject to change without notice.

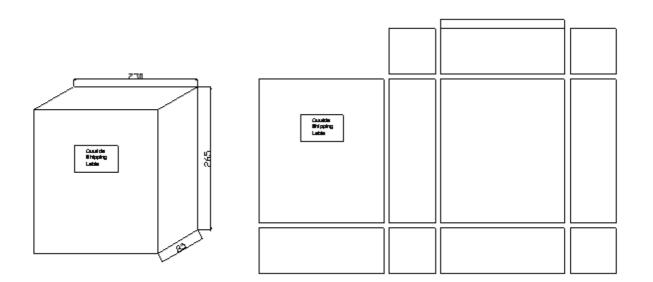
Anti Statistic Bag:

Unit:mm



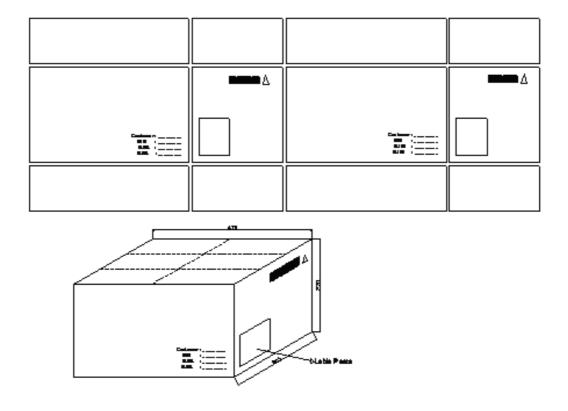
Small Box

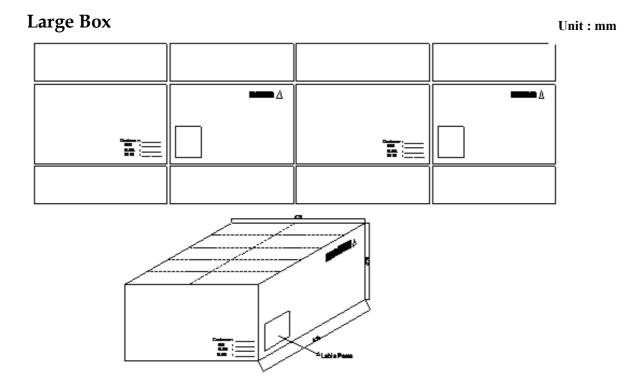
Unit : mm



Middle Box

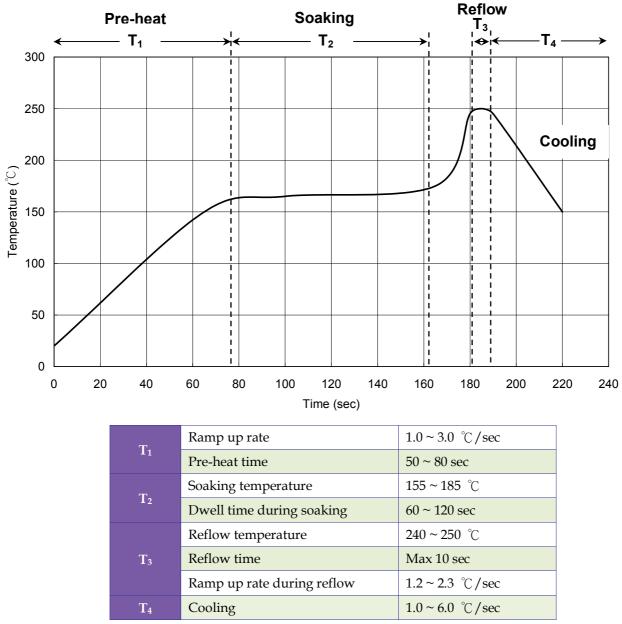
Unit : mm





Recommended Solder Profile

Soldering Recommended soldering conditions:



Note: Suggest using Sn96Ag3Cu0.5 lead free solder.

Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED if necessary.

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